THE DATASHEET OF

MAX539BCSA+T

19-0172; Rev 6; 2/97

MAXIM

+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

General Description

The MAX531/MAX538/MAX539 are low-power, voltage-output, 12-bit digital-to-analog converters (DACs) specified for single +5V power-supply operation. The MAX531 can also be operated with ±5V supplies. The MAX538/MAX539 draw only 140µA, and the MAX531 (with internal reference) draws only 260µA. The MAX538/MAX539 come in 8-pin DIP and SO packages, while the MAX531 comes in 14-pin DIP and SO packages. All parts have been trimmed for offset voltage, gain, and linearity, so no further adjustment is necessary.

The MAX538's buffer is fixed at a gain of +1 and the MAX539's buffer at a gain of +2. The MAX531's internal op amp may be configured for a gain of +1 or +2, as well as for unipolar or bipolar output voltages. The MAX531 can also be used as a four-quadrant multiplier without external resistors or op amps.

For parallel data inputs, see the MAX530 data sheet.

Applications

Battery-Powered Test Instruments

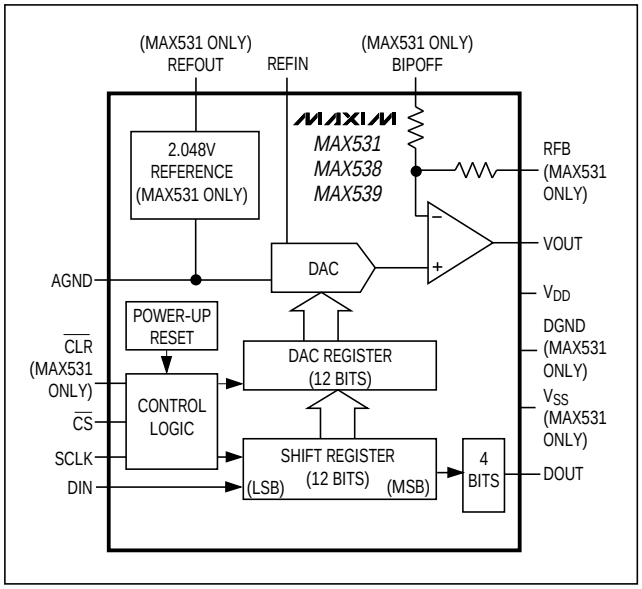
Digital Offset and Gain Adjustment

Battery-Operated/Remote Industrial Controls

Machine and Motion Control Devices

Cellular Telephones

Functional Diagram



Features

- ♦ **Operate from Single +5V Supply**
- ♦ **Buffered Voltage Output**
- ♦ **Internal 2.048V Reference (MAX531)**
- ♦ **140µA Supply Current (MAX538/MAX539)**
- ♦ **INL = ±1/2LSB (max)**
- ♦ **Guaranteed Monotonic over Temperature**
- ♦ **Flexible Output Ranges:**
  0V to V_{DD} (MAX531/MAX539)
  V_{SS} to V_{DD} (MAX531)
  0V to 2.6V (MAX531/MAX538)
- ♦ **8-Pin SO/DIP (MAX538/MAX539)**
- ♦ **Power-On Reset**
- ♦ **Serial Data Output for Daisy-Chaining**

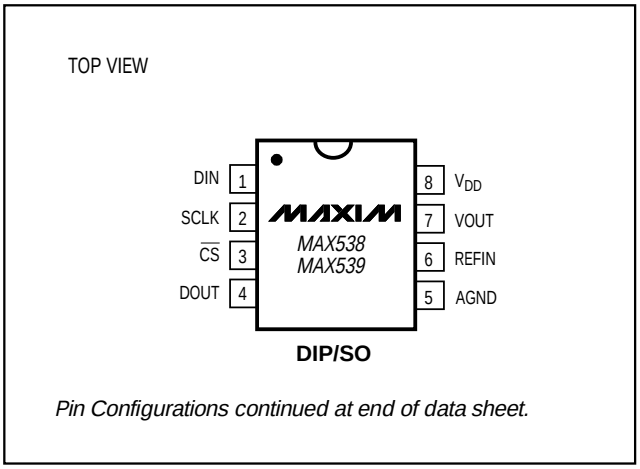
Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE	ERROR (LSB)
MAX531ACPD	0°C to +70°C	14 Plastic DIP	±1/2
MAX531BCPD	0°C to +70°C	14 Plastic DIP	±1
MAX531ACSD	0°C to +70°C	14 SO	±1/2
MAX531BCSD	0°C to +70°C	14 SO	±1
MAX531BC/D	0°C to +70°C	Dice*	±1

Ordering Information continued at end of data sheet.

**Dice are specified at T_A = +25°C only.*

Pin Configurations



DIP/SO

Pin Configurations continued at end of data sheet.

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+5V, Low-Power, Voltage-Output Serial 12-Bit DACs

ABSOLUTE MAXIMUM RATINGS

V_{DD} to DGND and V_{DD} to AGND .....-0.3V, +6V
V_{SS} to DGND and V_{SS} to AGND .....-6V, +0.3V
V_{DD} to V_{SS} .....-0.3V, +12V
AGND to DGND.....-0.3V, +0.3V
Digital Input Voltage to DGND .....-0.3V, (V_{DD} + 0.3V)
REFIN .....(V_{SS} - 0.3V), (V_{DD} + 0.3V)
REFOUT to AGND .....-0.3V, (V_{DD} + 0.3V)
RFB .....(V_{SS} - 0.3V), (V_{DD} + 0.3V)
BIPOFF.....(V_{SS} - 0.3V), (V_{DD} + 0.3V)
V_{OUT} (Note 1) .....V_{SS}, V_{DD}
Continuous Current, Any Pin.....-20mA, +20mA

Continuous Power Dissipation (T_A = +70°C)
8-Pin Plastic DIP (derate 9.09mW/°C above +70°C)....727mW
8-Pin SO (derate 5.88mW/°C above +70°C) 471mW
14-Pin Plastic DIP (derate 10.00mW/°C above +70°C)...800mW
14-Pin SO (derate 8.33mW/°C above +70°C) 667mW
Operating Temperature Ranges
MAX53_ _C_ _ .....0°C to +70°C
MAX53_ _E_ _ .....-40°C to +85°C
Storage Temperature Range .....-65°C to +165°C
Lead Temperature (soldering, 10sec) .....+300°C

Note 1: The output may be shorted to V_{DD}, V_{SS}, or AGND if the package power dissipation limit is not exceeded.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

(V_{DD} = +5V ±10%, V_{SS} = 0V, AGND = DGND = 0V, REFIN = 2.048V (external), RFB = BIPOFF = VOUT (MAX531), C_{REFOUT} = 33µF (MAX531), R_L = 10kΩ, C_L = 100pF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
STATIC PERFORMANCE						
Resolution	N		12			Bits
Relative Accuracy (Note 2)	INL	MAX53_AC/E			±0.5	LSB
		MAX53_BC/E			±1	
Differential Nonlinearity	DNL	Guaranteed monotonic			±1	LSB
Unipolar Offset Error	V_{OS}	MAX53_ _C/E	0		8	LSB
Unipolar Offset Tempco	TCV_{OS}			3		ppm/°C
Gain Error (Note 2)	GE	MAX53_ _C/E			±1	LSB
Gain-Error Tempco				1		ppm/°C
Power-Supply Rejection Ratio (Note 3)	PSRR	4.5V ≤ V_{DD} ≤ 5.5V		0.4	1	LSB/V
VOLTAGE OUTPUT (VOUT)						
Output Voltage Range		MAX531 (G = +1), MAX538	0		V_{DD} - 2	V
		MAX531 (G = +2), MAX539	0		V_{DD} - 0.4	
Output Load Regulation		VOUT = 2V, R_L = 2kΩ			1	LSB
Short-Circuit Current	I_{SC}			12		mA
REFERENCE INPUT (REFIN)						
Voltage Range			0		V_{DD} - 2	V
Input Resistance		Code dependent, minimum at code 555 hex	40			kΩ
Input Capacitance		Code dependent (Note 4)	10		50	pF
AC Feedthrough		REFIN = 1kHz, 2Vp-p		-80		dB

ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)

(V_{DD} = +5V ±10%, V_{SS} = 0V, AGND = DGND = 0V, REFIN = 2.048V (external), RFB = BIPOFF = VOUT (MAX531), C_{REFOUT} = 33µF (MAX531), R_L = 10kΩ, C_L = 100pF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
REFERENCE OUTPUT (REFOUT—MAX531 only)							
Reference Output Voltage		V_{DD} = 5.0V	T_A = +25°C	2.024	2.048	2.072	V
			MAX531BC	2.017		2.079	
			MAX531BE	2.013		2.083	
Temperature Coefficient	TC_{REFOUT}	MAX531AC/AE/AM/BM			30	50	ppm/°C
		MAX531BC/BE			30		
Resistance	R_{REFOUT}	(Note 5)			0.5	2	Ω
Power-Supply Rejection Ratio	PSRR	4.5V ≤ V_{DD} ≤ 5.5V				300	µV/V
Noise Voltage	e_n	0.1Hz to 10kHz			400		µVp-p
Minimum Required External Capacitor	C_{MIN}			3.3			µF
DIGITAL INPUTS (DIN, SCLK, $\overline{CS}$, $\overline{CLR}$)							
Input High	V_{IH}			2.4			V
Input Low	V_{IL}					0.8	V
Input Current	I_{IN}	V_{IN} = 0V or V_{DD}				±1	µA
Input Capacitance	C_{IN}				8		pF
DIGITAL OUTPUT (DOUT)							
Output High	V_{OH}	I_{SOURCE} = 2mA		V_{DD} - 1			V
Output Low	V_{OL}	I_{SINK} = 2mA				0.4	V
DYNAMIC PERFORMANCE							
Voltage-Output Slew Rate	SR	T_A = +25°C		0.15	0.25		V/µs
Voltage-Output Settling Time		To ±1/2LSB, VOUT = 2V			25		µs
Digital Feedthrough		$\overline{CS}$ = V_{DD}, DIN = 100kHz			5		nV-s
Signal-to-Noise plus Distortion	SINAD	REFIN = 1kHz, 2Vp-p (G = +1 or +2), code = FFF hex			68		dB
POWER SUPPLY							
Positive Supply Voltage	V_{DD}			4.5		5.5	V
Power-Supply Current	I_{DD}	All inputs = 0V or V_{DD}, output = no load	MAX531		260	400	µA
			MAX538, MAX539		140	300	
SWITCHING CHARACTERISTICS							
$\overline{CS}$ Setup Time	t_{CSS}			20			ns
SCLK Fall to $\overline{CS}$ Fall Hold Time	t_{CSH0}			15			ns
SCLK Fall to $\overline{CS}$ Rise Hold Time	t_{CSH1}			0			ns
SCLK High Width	t_{CH}			35			ns
SCLK Low Width	t_{CL}			35			ns
DIN Setup Time	t_{DS}			45			ns
DIN Hold Time	t_{DH}			0			ns
DOUT Valid Propagation Delay	t_{DO}	C_L = 50pF				80	ns
$\overline{CS}$ High Pulse Width	t_{CSW}			20			ns
$\overline{CLR}$ Pulse Width	t_{CLR}			25			ns
$\overline{CS}$ Rise to SCLK Rise Setup Time	t_{CS1}			50			ns

ELECTRICAL CHARACTERISTICS—Dual Supplies (MAX531 Only)

(V_{DD} = +5V ±10%, V_{SS} = -5V ±10%, AGND = DGND = 0V, REFIN = 2.048V (external), RFB = BIPOFF = VOUT, C_{REFOUT} = 33µF, R_L = 10kΩ, C_L = 100pF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Resolution	N			12			Bits
Relative Accuracy	INL	Tested at V_{DD} = 5V, V_{SS} = -5V	MAX531AC/E			±0.5	LSB
			MAX531BC/E			±1	
Differential Nonlinearity	DNL	Guaranteed monotonic				±1	LSB
Bipolar Offset Error	V_{OS}	BIPOFF = REFIN, MAX531_C/E				±8	LSB
Bipolar Offset Tempco	TCV_{OS}	BIPOFF = REFIN			3		ppm/°C
Gain Error (Unipolar or Bipolar)	GEU	MAX531_C/E				±1	LSB
Gain-Error Tempco					1		ppm/°C
Power-Supply Rejection Ratio (Note 3)	PSRR	4.5V ≤ V_{DD} ≤ 5.5V, -5.5V ≤ V_{SS} ≤ -4.5V			0.4	1	LSB/V
REFERENCE INPUT (REFIN)							
Voltage Range				V_{SS} + 2		V_{DD} - 2	V
Input Resistance		Code dependent, minimum at code 555 hex		40			kΩ
Input Capacitance		Code dependent (Note 4)		10		50	pF
AC Feedthrough		REFIN = 1kHz, 2.0Vp-p			-80		dB
REFERENCE OUTPUT (REFOUT—MAX531 only)							
Reference Output Voltage		V_{DD} = 5.0V	T_A = +25°C	2.024	2.048	2.072	V
			MAX531BC	2.017		2.079	
			MAX531BE	2.013		2.083	
Temperature Coefficient	TC_{REFOUT}	MAX531AC/AE/AM/BM			30	50	ppm/°C
		MAX531BC/BE			30		
Resistance	R_{REFOUT}	(Note 5)			0.5	2	Ω
Power-Supply Rejection Ratio	PSRR	4.5V ≤ V_{DD} ≤ 5.5V				300	µV/V
Noise Voltage	e_n	0.1Hz to 10kHz			400		µVp-p
Minimum Required External Capacitor	C_{MIN}			3.3			µF
DIGITAL INPUTS (DIN, SCLK, $\overline{CS}$)							
Input High	V_{IH}			2.4			V
Input Low	V_{IL}					0.8	V
Input Current	I_{IN}	V_{IN} = 0V or V_{DD}				±1	µA
Input Capacitance	C_{IN}				8		pF
DIGITAL OUTPUT (DOUT)							
Output High	V_{OH}	I_{SOURCE} = 2mA		V_{DD} - 1			V
Output Low	V_{OL}	I_{SINK} = 2mA				0.4	V

ELECTRICAL CHARACTERISTICS—Dual Supplies (MAX531 Only) (continued)

(V_{DD} = +5V ±10%, V_{SS} = -5V ±10%, AGND = DGND = 0V, REFIN = 2.048V (external), RFB = BIPOFF = VOUT, C_{REFOUT} = 33µF, R_L = 10kΩ, C_L = 100pF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
VOLTAGE OUTPUT (VOUT)						
Output Voltage Range		MAX531 (G = +1)	V_{SS} + 2		V_{DD} - 2	V
		MAX531 (G = +2)	V_{SS} + 0.4		V_{DD} - 0.4	
Output Load Regulation		VOUT = 2V, R_L = 2kΩ			1	LSB
Short-Circuit Current	I_{SC}			12		mA
DYNAMIC PERFORMANCE						
Voltage-Output Slew Rate	SR		0.15	0.25		V/µs
Voltage-Output Settling Time		To ±1/2LSB, VOUT = 2V		25		µs
Digital Feedthrough		Step 000 hex to FFF hex		5		nV-s
Signal-to-Noise plus Distortion	SINAD	REFIN = 1kHz, 2Vp-p, (G = +1)		68		dB
		REFIN = 1kHz, 2Vp-p, (G = +2)		68		
POWER SUPPLY						
Positive Supply Voltage	V_{DD}		4.5		5.5	V
Negative Supply Voltage	V_{SS}		-5.5		0	V
Positive Supply Current	I_{DD}	All inputs = 0V or V_{DD}, no load		260	400	µA
Negative Supply Current	I_{SS}	All inputs = 0V or V_{DD}, no load		-120	-200	µA
SWITCHING CHARACTERISTICS						
$\overline{CS}$ Setup Time	t_{CSS}		20			ns
SCLK Fall to $\overline{CS}$ Fall Hold Time	t_{CSH0}		15			ns
SCLK Fall to $\overline{CS}$ Rise Hold Time	t_{CSH1}		0			ns
SCLK High Width	t_{CH}		35			ns
SCLK Low Width	t_{CL}		35			ns
DIN Setup Time	t_{DS}		45			ns
DIN Hold Time	t_{DH}		0			ns
DOUT Valid Propagation Delay	t_{DO}	C_L = 50pF			80	ns
$\overline{CS}$ High Pulse Width	t_{CSW}		20			ns
$\overline{CLR}$ Pulse Width	t_{CLR}		25			ns
$\overline{CS}$ Rise to SCLK Rise Setup Time	t_{CS1}		50			ns

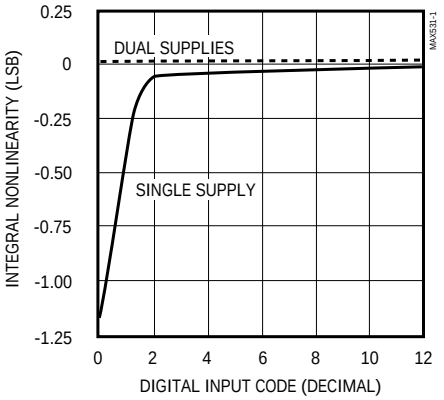
Note 2: In single-supply operation, INL and GE calculated from code 11 to code 4095. Tested at V_{DD} = +5V.
Note 3: This specification applies to both gain-error power-supply rejection ratio and offset-error power-supply rejection ratio.
Note 4: Guaranteed by design.
Note 5: Tested at I_{OUT} = 100µA. The reference can typically source up to 5mA (see *Typical Operating Characteristics*).

+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

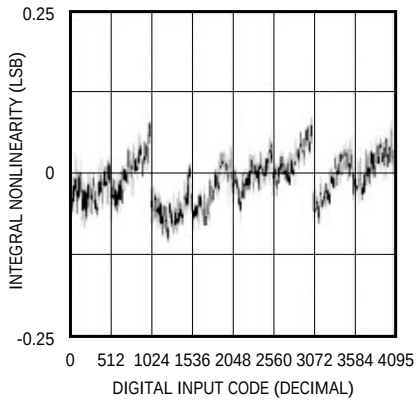
Typical Operating Characteristics

(V_{DD} = +5V, V_{REFIN} = 2.048V, T_A = +25°C, unless otherwise noted.)

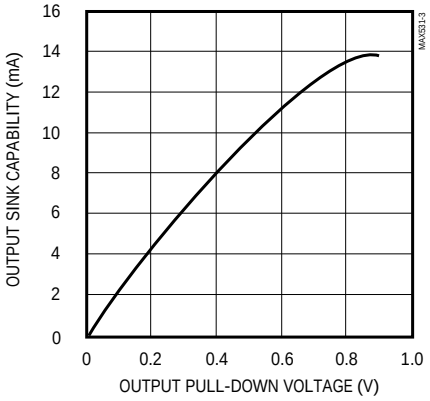
INTEGRAL NONLINEARITY vs. DIGITAL INPUT CODE (FIRST 12 CODES)



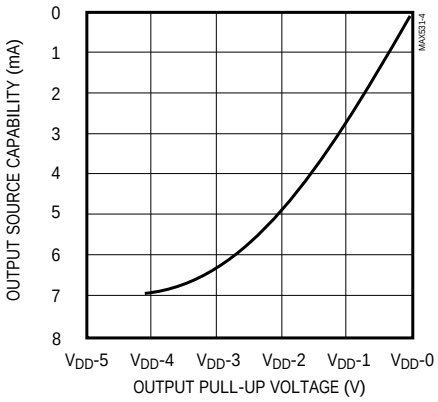
INTEGRAL NONLINEARITY vs. DIGITAL INPUT CODE (ALL CODES)



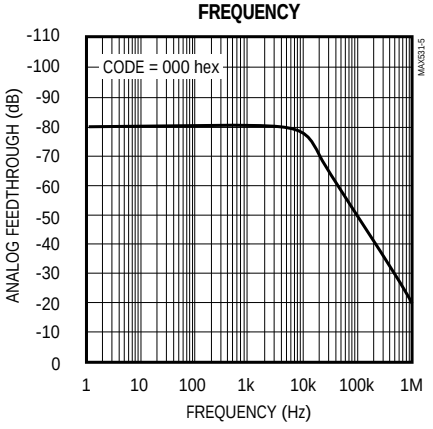
OUTPUT SINK CAPABILITY vs. OUTPUT PULL-DOWN VOLTAGE



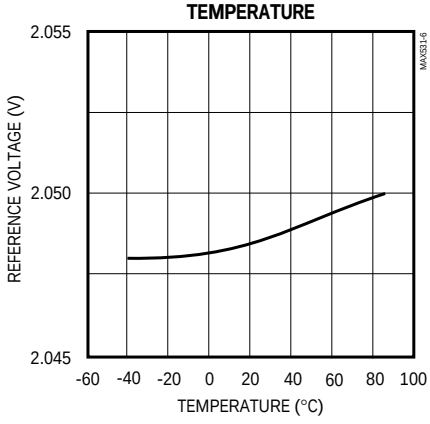
OUTPUT SOURCE CAPABILITY vs. OUTPUT PULL-UP VOLTAGE



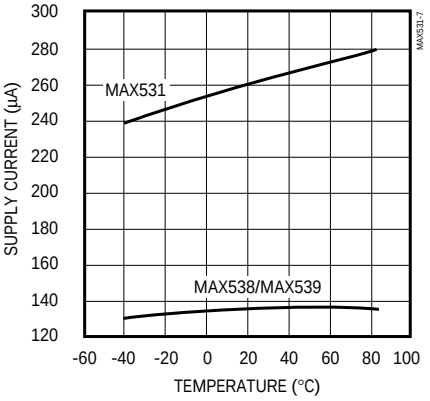
ANALOG FEEDTHROUGH vs. FREQUENCY



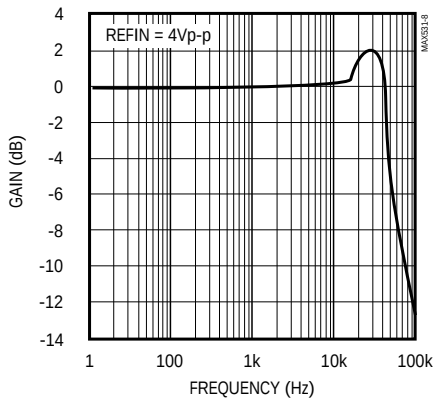
MAX531 REFERENCE VOLTAGE vs. TEMPERATURE



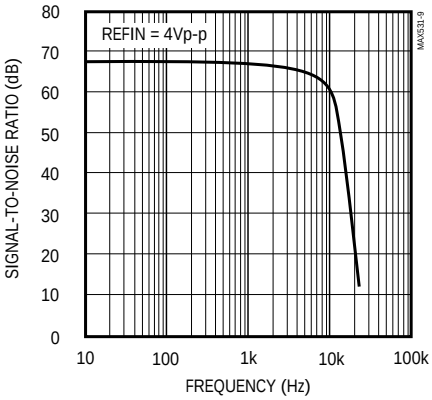
SUPPLY CURRENT vs. TEMPERATURE



MAX531 GAIN vs. FREQUENCY



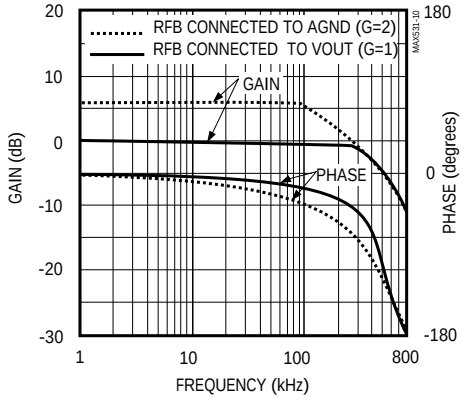
MAX531 AMPLIFIER SIGNAL-TO-NOISE RATIO



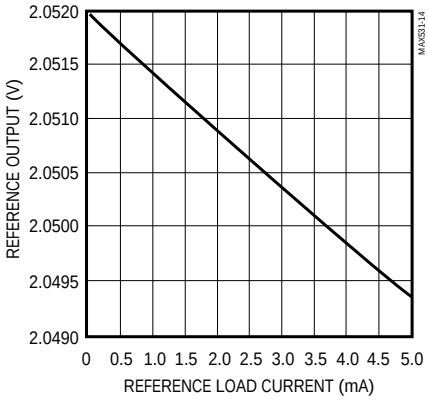
Typical Operating Characteristics (continued)

(V_{DD} = +5V, V_{REFIN} = 2.048V, T_A = +25°C, unless otherwise noted.)

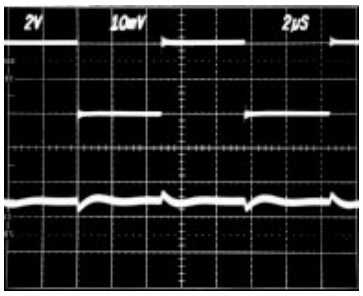
MAX531
GAIN AND PHASE vs. FREQUENCY



MAX531 REFERENCE OUTPUT VOLTAGE vs. REFERENCE LOAD CURRENT



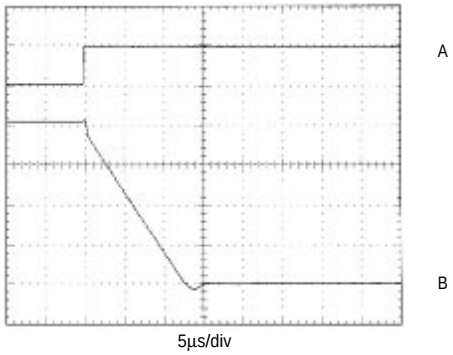
DIGITAL FEEDTHROUGH



2µs/div

$\overline{CS}$ = HIGH
A: DIN = 4Vp-p, 100kHz
B: VOUT, 10mV/div

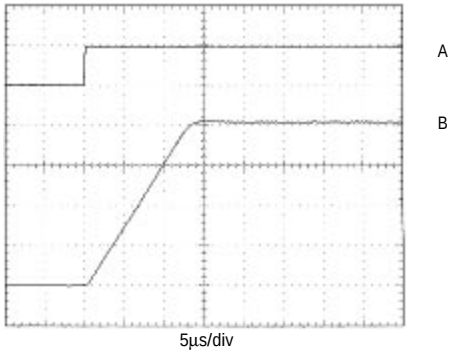
NEGATIVE SETTLING TIME (MAX531)



5µs/div

V_{DD} = ±5V, V_{REFIN} = 2V, BIPOLAR CONFIGURATION
A: $\overline{CS}$ RISING EDGE, 5V/div
B: VOUT, NO LOAD, 1V/div

POSITIVE SETTLING TIME (MAX531)



5µs/div

V_{DD} = ±5V, V_{REFIN} = 2V, BIPOLAR CONFIGURATION
A: $\overline{CS}$ RISING EDGE, 5V/div
B: VOUT, NO LOAD, 1V/div

+5V, Low-Power, Voltage-Output Serial 12-Bit DACs

Pin Description

PIN		NAME	FUNCTION
MAX531	MAX538 MAX539		
1	—	BIPOFF	Bipolar Offset/Gain Resistor
2	1	DIN	Serial Data Input
3	—	$\overline{CLR}$	Clear. Asynchronously sets DAC register to 000 hex.
4	2	SCLK	Serial Clock Input
5	3	$\overline{CS}$	Chip Select, active low
6	4	DOUT	Serial Data Output for daisy-chaining
7	—	DGND	Digital Ground
8	5	AGND	Analog Ground
9	6	REFIN	Reference Input
10	—	REFOUT	Reference Output, 2.048V
11	—	V_{SS}	Negative Power Supply
12	7	VOUT	DAC Output
13	8	V_{DD}	Positive Power Supply
14	—	RFB	Feedback Resistor

Detailed Description

General DAC Discussion

The MAX531/MAX538/MAX539 use an “inverted” R-2R ladder network with a single-supply CMOS op amp to convert 12-bit digital data to analog voltage levels (see *Functional Diagram)*. The term “inverted” describes the ladder network because the REFIN pin in current-output DACs is the summing junction, or virtual ground, of an op amp. However, such use would result in the output voltage being the inverse of the reference voltage. The MAX531/MAX538/MAX539’s topology makes the output the same polarity as the reference input.

An internal reset circuit forces the DAC register to reset to 000 hex on power-up. Additionally, a clear $\overline{CLR}$ pin, when held low, sets the DAC register to 000 hex. $\overline{CLR}$ operates asynchronously and independently from the chip-select ($\overline{CS}$) pin.

Buffer Amplifier

The output buffer is a unity-gain stable, rail-to-rail output, BiCMOS op amp. Input offset voltage and CMRR are trimmed to achieve better than 12-bit performance. Settling time is 25µs to 0.01% of final value. The settling time is considerably longer when the DAC code is initially set to 000 hex, because at this code the op amp is completely debiased. Start from code 001 hex if necessary. The output is short-circuit protected and can drive a 2kΩ load with more than 100pF load capacitance.

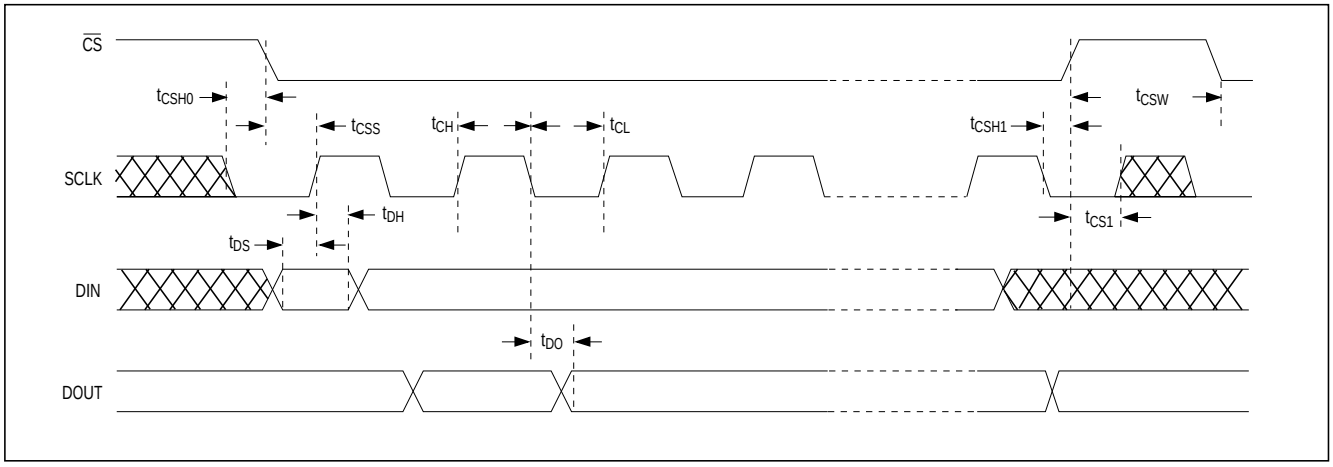


Figure 1. Timing Diagram

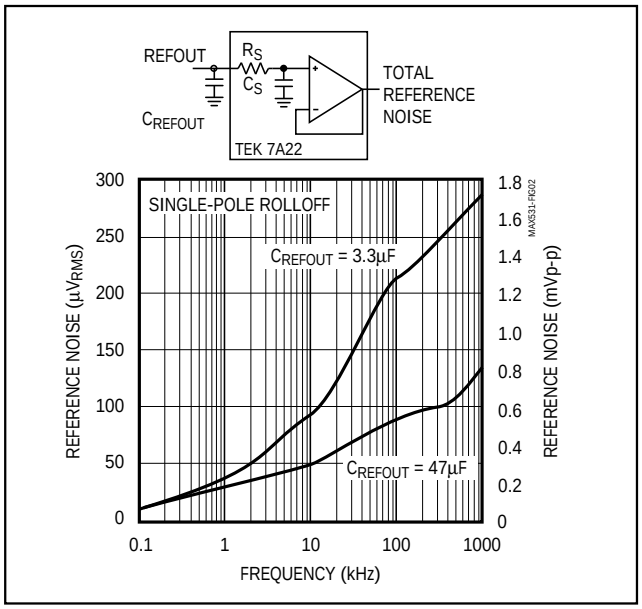


Figure 2. Reference Noise vs. Frequency

Internal Reference (MAX531 only)

The on-chip reference is lesser trimmed to generate 2.048V at REFOUT. The output stage can source and sink current, so REFOUT can settle to the correct voltage quickly in response to code-dependent loading changes. Typically, source current is 5mA and sink current is 100µA.

REFOUT connects the internal reference to the R-2R DAC ladder at REFIN. The R-2R ladder draws 50µA maximum load current. If any other connection is made to REFOUT, ensure that the total load current is less than 100µA to avoid gain errors.

For applications requiring very low-noise performance, connect a 33µF capacitor from REFOUT to AGND. If noise is not a concern, a lower value capacitor (3.3µF min) may be used. To reduce noise further, insert a buffered RC filter between REFOUT and REFIN (Figure 2). The reference bypass capacitor, C_{REFOUT}, is still required for reference stability. In applications not requiring the reference, connect REFOUT to V_{DD} or use the MAX538 or MAX539 (no internal reference).

External Reference

An external reference in the range (V_{SS} + 2V) to (V_{DD} - 2V) may be used with the MAX531 in dual-supply operation. With the MAX538/MAX539 or the MAX531 in single-supply use, the reference must be positive and may not exceed V_{DD} - 2V. The reference voltage determines the DAC's full-scale output. The DAC input resistance is code dependent and is minimum (40kΩ) at code 555 hex and virtually infinite at code 000 hex. REFIN's input capacitance is also code dependent and has a 50pF maximum value at several codes. Because of the code-dependent nature of reference input impedances, a high-quality, low-output-impedance amplifier (such as the MAX480 low-power, precision op amp) should be used.

If an upgrade to the internal reference is required, the 2.5V MAX873A is suitable: ±15mV initial accuracy, TCV_{OUT} = 7ppm/°C (max).

Logic Interface

The MAX531/MAX538/MAX539 logic inputs are designed to be compatible with TTL or CMOS logic levels. However, to achieve the lowest power dissipation, drive the digital inputs with rail-to-rail CMOS logic. With TTL logic levels, the power requirement increases by a factor of approximately 2.

Serial Clock and Update Rate

Figure 1 shows the MAX531/MAX538/MAX539 timing. The maximum serial clock rate is given by 1 / (t_{CH} + t_{CL}), approximately 14MHz. The digital update rate is limited by the chip-select period, which is 16 x (t_{CH} + t_{CL}) + t_{CSW}. This equals a 1.14µs, or 877kHz, update rate. However, the DAC settling time to 12 bits is 25µs, which may limit the update rate to 40kHz for full-scale step transitions.

_____Applications Information

Refer to Figures 3a and 3b for typical operating connections.

Serial Interface

The MAX531/MAX538/MAX539 use a three-wire serial interface that is compatible with SPI™, QSPI™ (CPOL = CPHA = 0), and Microwire™ standards as shown in Figures 4 and 5. The DAC is programmed by writing two 8-bit words (see Figure 1 and the *Functional Diagram*). Sixteen bits of serial data are clocked into the DAC MSB first with the MSB preceded by four fill (dummy) bits. The four dummy bits are not normally needed. They are required **only** when DACs are daisy-chained. Data is clocked in on SCLK's rising edge while $\overline{CS}$ is low. The serial input data is held in a 16-bit serial shift register. On $\overline{CS}$'s rising edge, the 12 least significant bits are transferred to the DAC register and update the DAC. With $\overline{CS}$ high, data cannot be clocked into the MAX531/MAX538/MAX539.

The MAX531/MAX538/MAX539 input data in 16-bit blocks. The SPI and Microwire interfaces output data in 8-bit blocks, thereby requiring two write cycles to input data to the DAC. The QSPI interface allows variable data input from eight to 16 bits, and can be loaded into the DAC in one write cycle.

SPI and QSPI are trademarks of Motorola, Inc.
Microwire is a trademark of National Semiconductor Corp.

+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

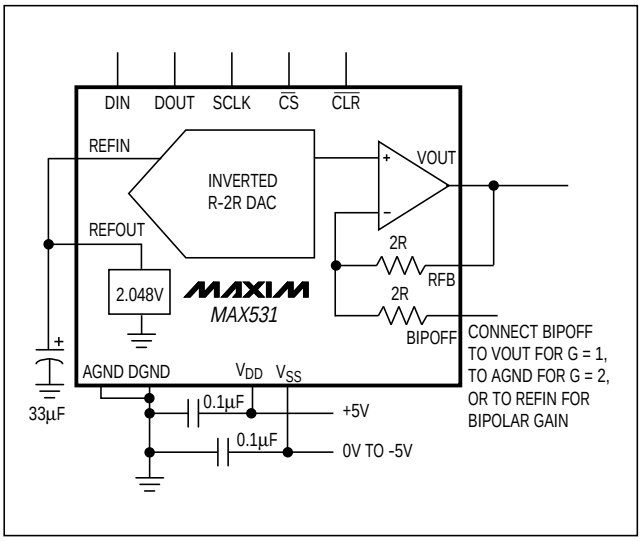


Figure 3a. MAX531 Typical Operating Circuit

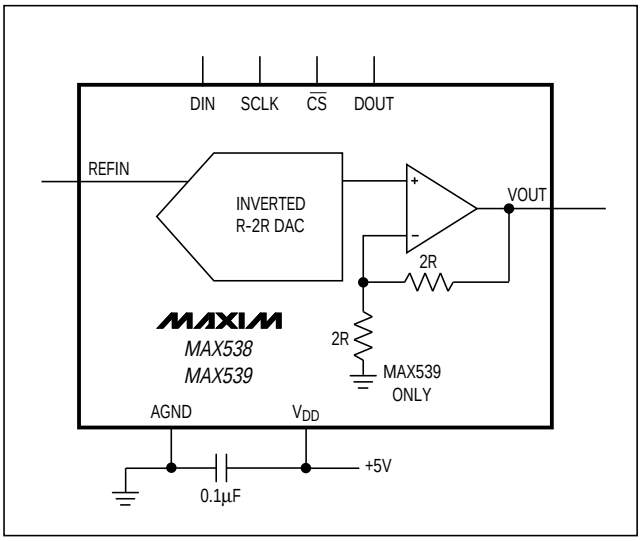


Figure 3b. MAX538/MAX539 Typical Operating Circuit

Daisy-Chaining Devices

The serial output, DOUT, allows cascading of two or more DACs. The data at DIN appears at DOUT, delayed by 16 clock cycles plus one clock width. For low power, DOUT is a CMOS output that does not require an external pull-up resistor. DOUT does **not** go into a high-impedance state when $\overline{CS}$ is high. DOUT changes on SCLK's falling edge when $\overline{CS}$ is low. When $\overline{CS}$ is high, DOUT remains in the state of the last data bit.

Any number of MAX531/MAX538/MAX539 DACs can be daisy-chained by connecting the DOUT of one device to the DIN of the next device in the chain. For proper timing, ensure that t_{CL} ($\overline{CS}$ low to SCLK high) is greater than $t_{DO} + t_{DS}$.

Unipolar Configuration

The MAX531 is configured for a gain of +1 (0V to V_{REFIN} unipolar output) by connecting BIPOFF and RFB to VOUT (Figure 6). The converter operates from either single or dual supplies in this configuration. See Table 1 for the DAC-latch contents (input) vs. the analog VOUT (output). In this range, 1LSB = V_{REFIN} (2^{-12}). The MAX538 is internally configured for unipolar gain = +1 operation.

A gain of +2 (0V to $2V_{REFIN}$ unipolar output) is set up by connecting BIPOFF to AGND and RFB to VOUT (Figure 7). Table 2 shows the DAC-latch contents vs. VOUT. The MAX531 operates from either single or dual supplies in this mode. In this range, 1LSB = (2)(V_{REFIN}) (2^{-12}) = (V_{REFIN})(2^{-11}). The MAX539 is internally configured for unipolar gain = +2 operation.

Bipolar Configuration

A bipolar range is set up by connecting BIPOFF to REFIN and RFB to VOUT, and operating from dual (±5V) supplies (Figure 8). Table 3 shows the DAC-latch contents (input) vs. VOUT (output). In this range, 1LSB = V_{REFIN} (2^{-11}).

Four-Quadrant Multiplication

The MAX531 can be used as a four-quadrant multiplier by connecting BIPOFF to REFIN and RFB to VOUT, using (1) an offset binary digital code, (2) bipolar power supplies, using dual power supplies, and (3) a bipolar analog input at REFIN within the range V_{SS} + 2V to V_{DD} - 2V, as shown in Figure 9.

In general, a 12-bit DAC's output is (D) (V_{REFIN}) (G), where "G" is the gain (+1 or +2) and "D" is the binary representation of the digital input divided by 2^{12} or 4096. This formula is precise for unipolar operation. However, for bipolar, offset binary operation, the MSB is really a polarity bit. No resolution is lost, as there are the same number of steps. The output voltage, however, has been shifted from a range of, for example, 0V to 4.096V (G = +2) to a range of -2.048V to +2.048V.

Keep in mind that when using the DAC as a four-quadrant multiplier, the scale is skewed. Negative full scale is $-V_{REFIN}$, while positive full scale is $+V_{REFIN}$ - 1LSB.

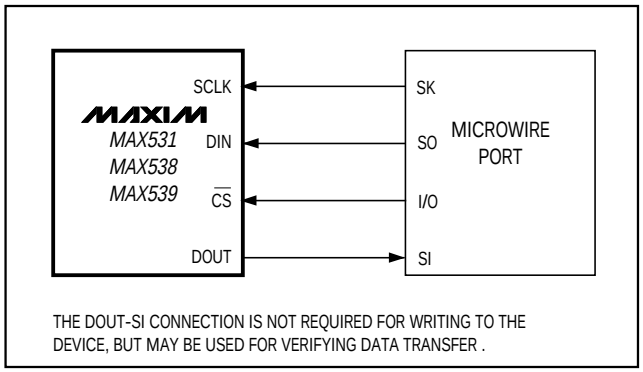


Figure 4. Microwire Connection

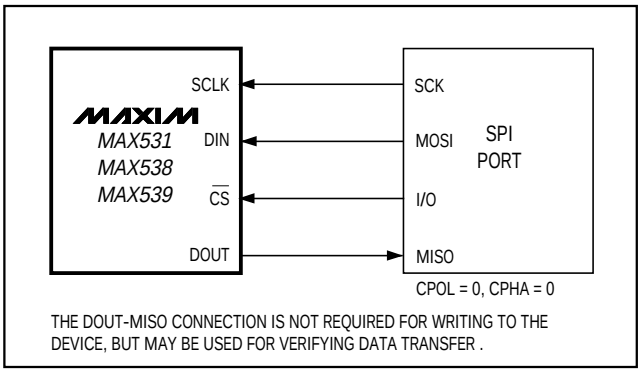


Figure 5. SPI/QSPI Connection

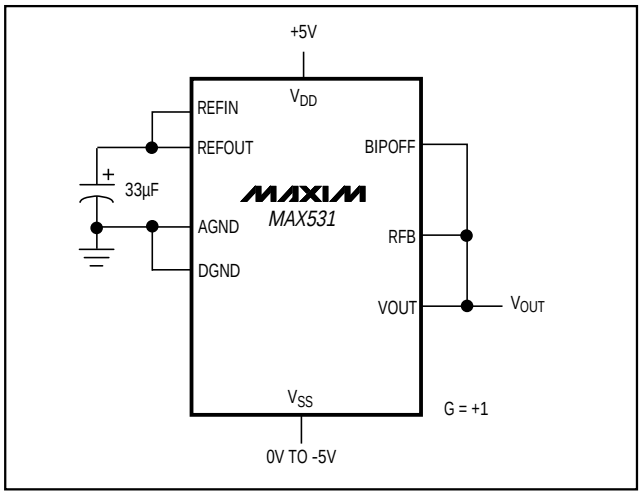


Figure 6. Unipolar Configuration (0V to +2.048V Output)

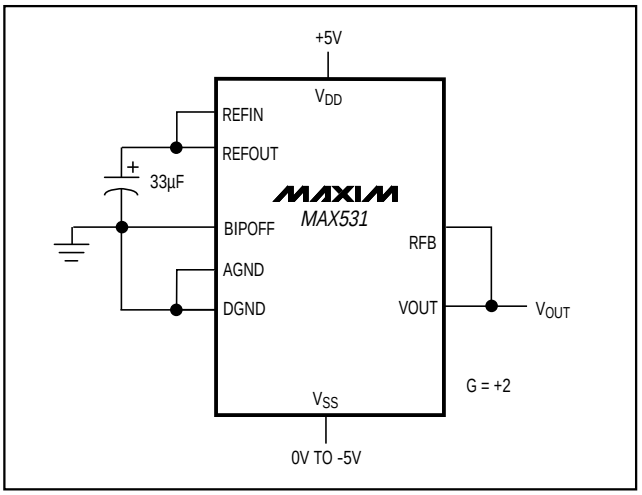


Figure 7. Unipolar Configuration (0V to +4.096V Output)

Table 1. Unipolar Binary Code Table (0V to V_{REFIN} Output), Gain = +1

INPUT	OUTPUT
1111 1111 1111	$(V_{REFIN})\frac{4095}{4096}$
1000 0000 0001	$(V_{REFIN})\frac{2049}{4096}$
1000 0000 0000	$(V_{REFIN})\frac{2048}{4096} = +V_{REFIN} / 2$
0111 1111 1111	$(V_{REFIN})\frac{2047}{4096}$
0000 0000 0001	$(V_{REFIN})\frac{1}{4096}$
0000 0000 0000	0V

Table 2. Unipolar Binary Code Table (0V to 2V_{REFIN} Output), Gain = +2

INPUT	OUTPUT
1111 1111 1111	$+2\ (V_{REFIN})\frac{4095}{4096}$
1000 0000 0001	$+2\ (V_{REFIN})\frac{2049}{4096}$
1000 0000 0000	$+2\ (V_{REFIN})\frac{2048}{4096} = +V_{REFIN}$
0111 1111 1111	$+2\ (V_{REFIN})\frac{2047}{4096}$
0000 0000 0001	$+2\ (V_{REFIN})\frac{1}{4096}$
0000 0000 0000	0V

+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

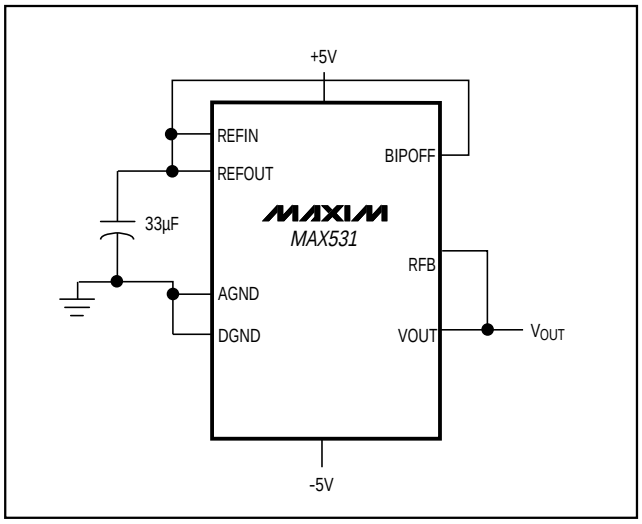


Figure 8. Bipolar Configuration (-2.048V to +2.048V Output)

Table 3. Bipolar (Offset Binary) Code Table (-V_{REFIN} to +V_{REFIN} Output)

INPUT	OUTPUT
1111 1111 1111	$(+V_{REFIN})\frac{2047}{2048}$
1000 0000 0001	$(+V_{REFIN})\frac{1}{2048}$
1000 0000 0000	0V
0111 1111 1111	$(-V_{REFIN})\frac{1}{2048}$
0000 0000 0001	$(-V_{REFIN})\frac{2047}{2048}$
0000 0000 0000	$(-V_{REFIN})\frac{2048}{2048} = -V_{REFIN}$

Single-Supply Linearity

As with any amplifier, the MAX531/MAX538/MAX539's output buffer can be positive or negative. When the offset is positive, it is easily accounted for (Figure 10). However, when the offset is negative, the buffer output cannot follow linearly when there is no negative supply. In that case, the amplifier output (VOUT) remains at ground until the DAC voltage is sufficient to overcome the offset and the output becomes positive.

Normally, linearity is measured after accounting for zero error and gain error. Since, in single-supply operation, the actual value of a negative offset is unknown, it cannot be accounted for during test. Additionally, the output buffer amplifier exhibits a nonlinearity near-zero output when operating with a single supply. To account for this nonlinearity in the MAX531/MAX538/MAX539, linearity and gain error are measured from code 11 to code 4095. The output buffer's offset and nonlinear behavior do not affect monotonicity, and these DACs are guaranteed monotonic starting with code zero. In dual-supply operation, linearity and gain error are measured from code 0 to 4095.

Power-Supply Bypassing and Ground Management

Best system performance is obtained with printed circuit boards that use separate analog and digital ground planes. Wire-wrap boards are not recommended. The two ground planes should be connected together at the low-impedance power-supply source.

DGND and AGND should be connected together at the chip. For the MAX531 in single-supply applications, connect V_{SS} to AGND at the chip. The best ground connection may be achieved by connecting the DAC's DGND and AGND pins together and connecting that point to the system analog ground plane. If the DAC's DGND is connected to the system digital ground, digital noise may get through to the DAC's analog portion.

Bypass V_{DD} (and V_{SS} in dual-supply mode) with a 0.1µF ceramic capacitor, connected between V_{DD} and AGND (and between V_{SS} and AGND). Mount with short leads close to the device. Ferrite beads may also be used to further isolate the analog and digital power supplies.

Figures 11a and 11b illustrate the grounding and bypassing scheme described.

Saving Power

When the DAC is not being used by the system, minimize power consumption by setting the appropriate code to minimize load current. For example, in bipolar mode, with a resistive load to ground, set the DAC code to mid-scale (Table 3). If there is no output load, minimize internal loading on the reference by setting the DAC to all 0s (on the MAX531, use $\overline{CLR}$). Under this condition, REFIN is high impedance and the op amp operates at its minimum quiescent current. Due to these low current levels, the output settling time for an input code close to 0 typically increases to 60µs (no more than 100µs).

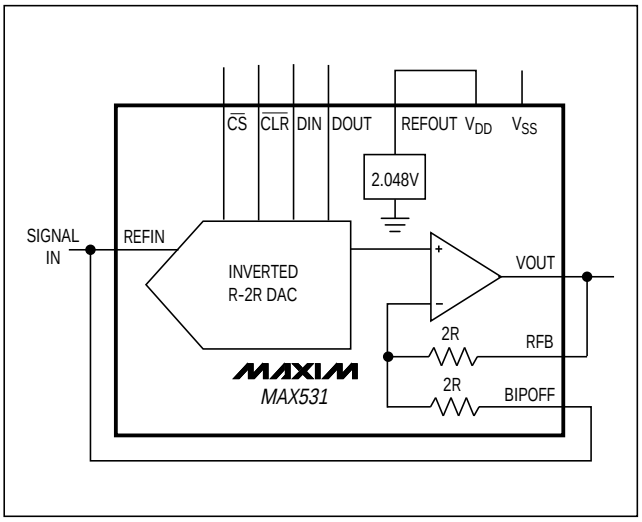


Figure 9. MAX531 Connected as Four-Quadrant Multiplier. The unused REFOUT is connected to V_{DD}.

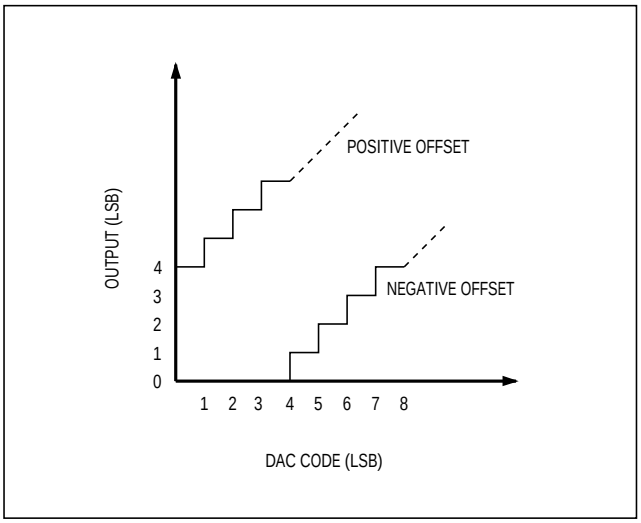


Figure 10. Single-Supply Offset

AC Considerations

Digital Feedthrough

High-speed serial data at any of the digital input or output pins may couple through the DAC package and cause internal stray capacitance to appear at the DAC output as noise, even though $\overline{CS}$ is held high (see *Typical Operating Characteristics*). This digital feedthrough is tested by holding $\overline{CS}$ high, transmitting 555 hex from DIN to DOUT.

Analog Feedthrough

Because of internal stray capacitance, higher frequency analog input signals may couple to the output as shown in the Analog Feedthrough vs. Frequency graph in the *Typical Operating Characteristics*. It is tested by holding $\overline{CS}$ high, setting the DAC code to all 0s, and sweeping REFIN.

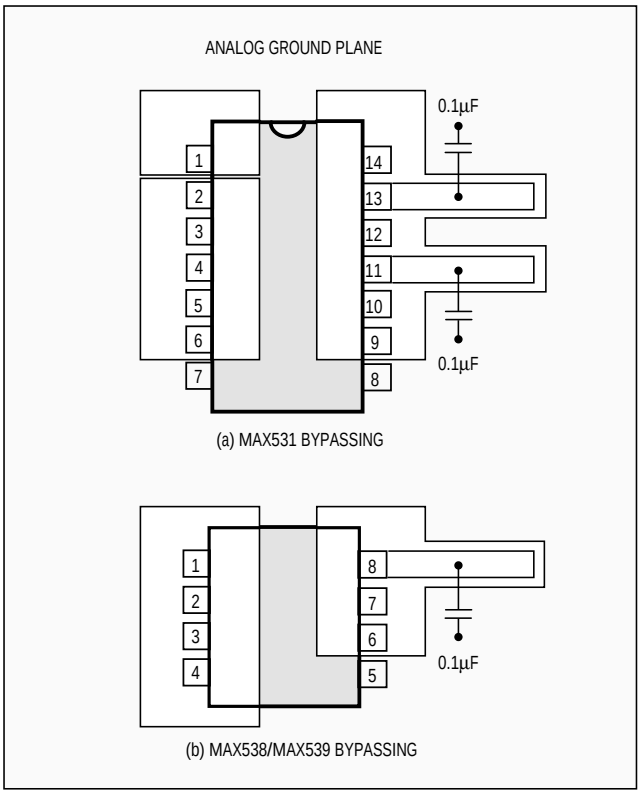


Figure 11. Power-Supply Bypassing

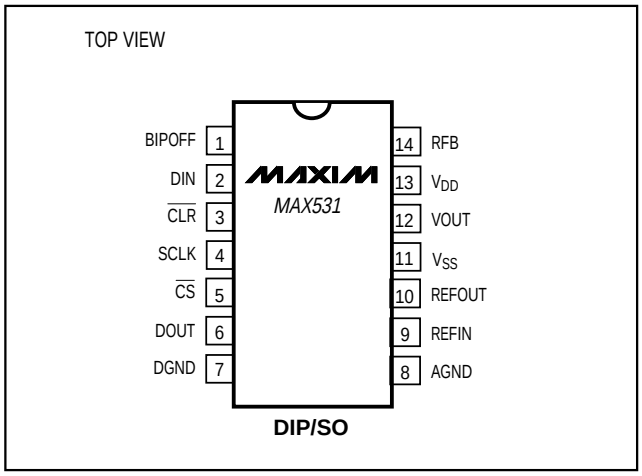
+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

Ordering Information (continued)

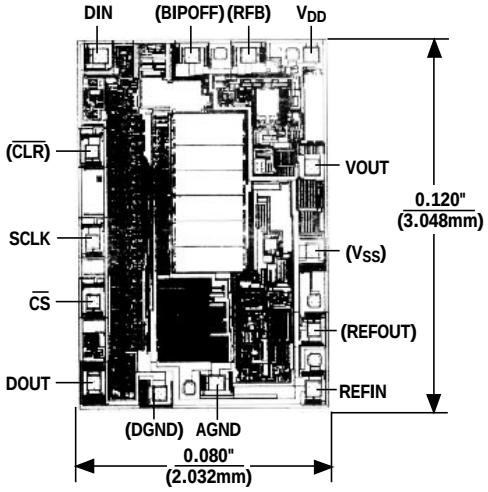
PART	TEMP. RANGE	PIN-PACKAGE	ERROR (LSB)
MAX531AEPD	-40°C to +85°C	14 Plastic DIP	±1/2
MAX531BEPD	-40°C to +85°C	14 Plastic DIP	±1
MAX531AESD	-40°C to +85°C	14 SO	±1/2
MAX531BESD	-40°C to +85°C	14 SO	±1
MAX538ACPA	0°C to +70°C	8 Plastic DIP	±1/2
MAX538BCPA	0°C to +70°C	8 Plastic DIP	±1
MAX538ACSA	0°C to +70°C	8 SO	±1/2
MAX538BCSA	0°C to +70°C	8 SO	±1
MAX538BC/D	0°C to +70°C	Dice*	±1
MAX538AEPA	-40°C to +85°C	8 Plastic DIP	±1/2
MAX538BEPA	-40°C to +85°C	8 Plastic DIP	±1
MAX538AESA	-40°C to +85°C	8 SO	±1/2
MAX538BESA	-40°C to +85°C	8 SO	±1
MAX539ACPA	0°C to +70°C	8 Plastic DIP	±1/2
MAX539BCPA	0°C to +70°C	8 Plastic DIP	±1
MAX539ACSA	0°C to +70°C	8 SO	±1/2
MAX539BCSA	0°C to +70°C	8 SO	±1
MAX539BC/D	0°C to +70°C	Dice*	±1
MAX539AEPA	-40°C to +85°C	8 Plastic DIP	±1/2
MAX539BEPA	-40°C to +85°C	8 Plastic DIP	±1
MAX539AESA	-40°C to +85°C	8 SO	±1/2
MAX539BESA	-40°C to +85°C	8 SO	±1

**Dice are specified at T_A = +25°C only.*

Pin Configurations (continued)



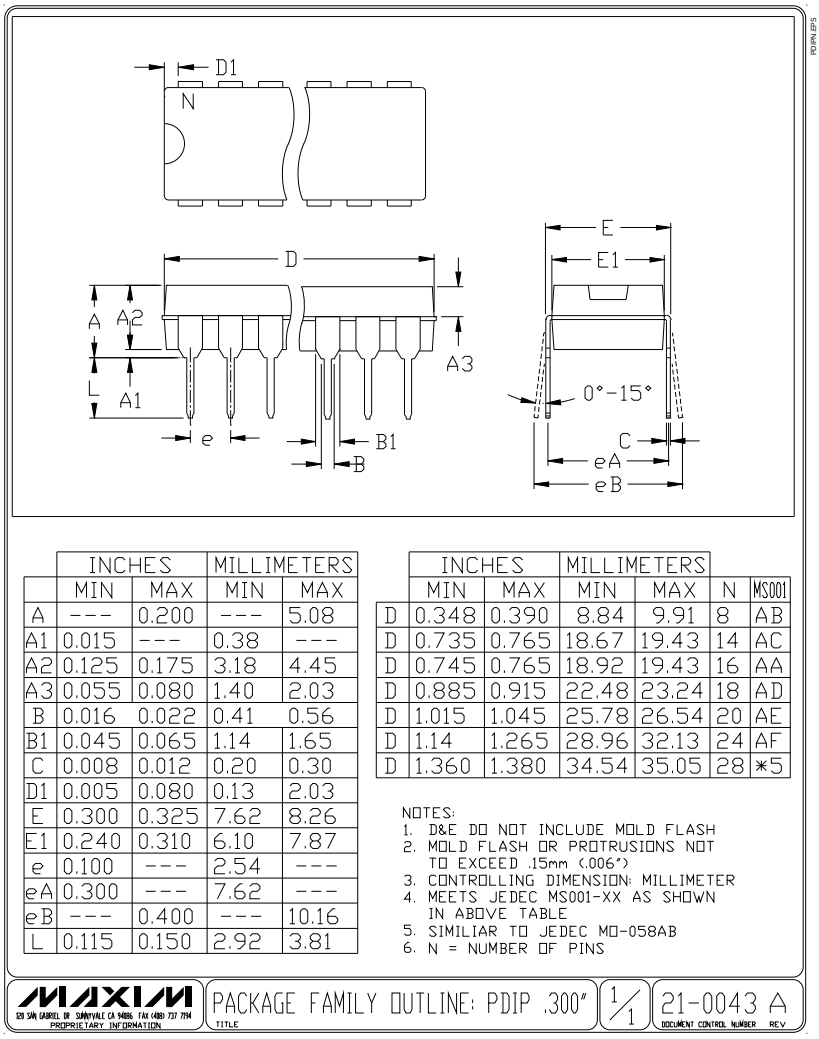
Chip Topography



( ) ARE FOR MAX531 ONLY.

TRANSISTOR COUNT: 922
SUBSTRATE CONNECTED TO V_{DD}

Package Information



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.200	---	5.08
A1	0.015	---	0.38	---
A2	0.125	0.175	3.18	4.45
A3	0.055	0.080	1.40	2.03
B	0.016	0.022	0.41	0.56
B1	0.045	0.065	1.14	1.65
C	0.008	0.012	0.20	0.30
D1	0.005	0.080	0.13	2.03
E	0.300	0.325	7.62	8.26
E1	0.240	0.310	6.10	7.87
e	0.100	---	2.54	---
eA	0.300	---	7.62	---
eB	---	0.400	---	10.16
L	0.115	0.150	2.92	3.81

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS001
D	0.348	0.390	8.84	9.91	8	AB
D	0.735	0.765	18.67	19.43	14	AC
D	0.745	0.765	18.92	19.43	16	AA
D	0.885	0.915	22.48	23.24	18	AD
D	1.015	1.045	25.78	26.54	20	AE
D	1.14	1.265	28.96	32.13	24	AF
D	1.360	1.380	34.54	35.05	28	*5

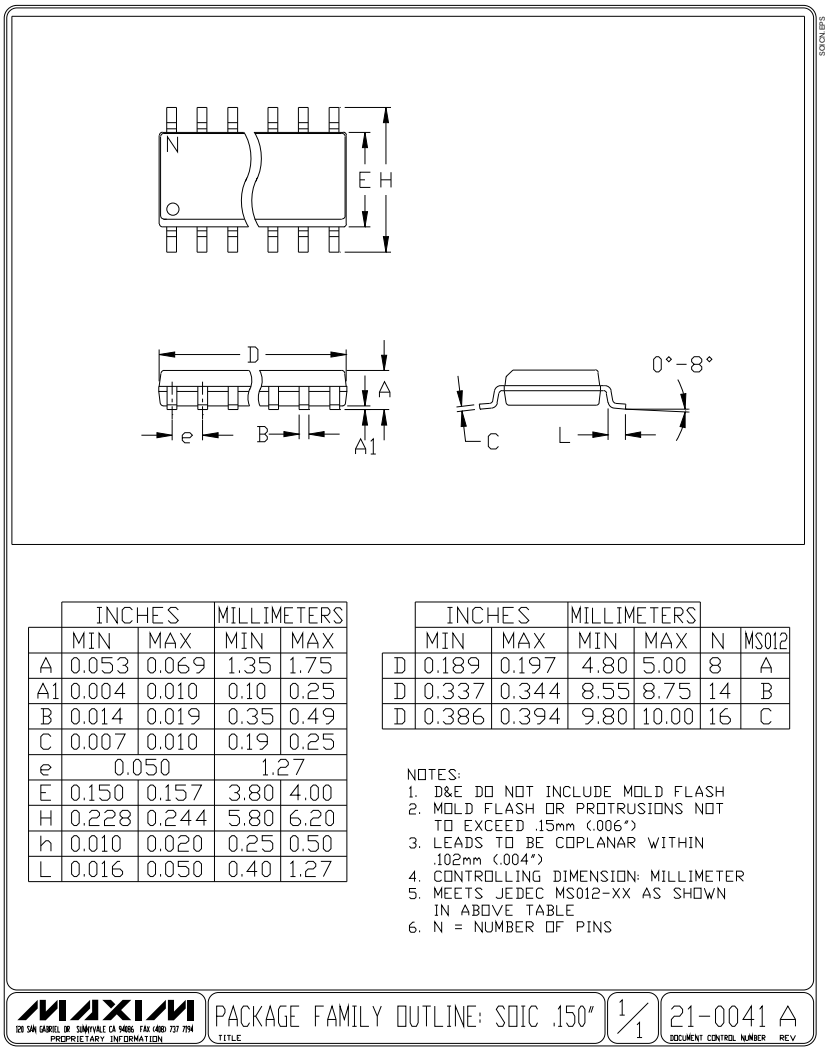
NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC MS001-XX AS SHOWN IN ABOVE TABLE
5. SIMILIAR TO JEDEC MO-058AB
6. N = NUMBER OF PINS

MAXIM — 120 SAN GABRIEL DR SUNNYVALE CA 94086 FAX (408) 737 7194 — PROPRIETARY INFORMATION

TITLE: PACKAGE FAMILY OUTLINE: PDIP .300" | 1/1 | DOCUMENT CONTROL NUMBER: 21-0043 A | REV: A

+5V, Low-Power, Voltage-Output, Serial 12-Bit DACs

Package Information (continued)



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050		1.27	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS012
D	0.189	0.197	4.80	5.00	8	A
D	0.337	0.344	8.55	8.75	14	B
D	0.386	0.394	9.80	10.00	16	C

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. LEADS TO BE COPLANAR WITHIN .102mm (.004")
4. CONTROLLING DIMENSION: MILLIMETER
5. MEETS JEDEC MS012-XX AS SHOWN IN ABOVE TABLE
6. N = NUMBER OF PINS

MAXIM 120 SAN GABRIEL DR SUNNYVALE CA 94086 FAX (408) 737 7194 PROPRIETARY INFORMATION

PACKAGE FAMILY OUTLINE: SOIC .150" (TITLE) | 1/1 | 21-0041 A (DOCUMENT CONTROL NUMBER / REV.)

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- Shortage Management
- Alternative Solution
- Excess Inventory Management